

SOP-8 N Channel Enhancement 沟道增强型 MOS Field Effect Transistor 场效应管

■Features 特点

Low on-resistance 低导通电阻

$R_{DS(ON)}=15m\Omega(\text{Type})@V_{GS}=10V$

$R_{DS(ON)}=18m\Omega(\text{Type})@V_{GS}=4.5V$

■Applications 应用

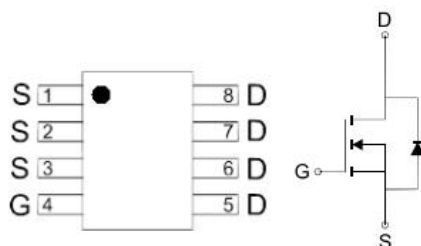
Load Switch 负载开关

Motor Drives 马达驱动

DC-DC Conversion 升压转换

Synchronous Rectification 同步整流

■Internal Schematic Diagram 内部结构



■Absolute Maximum Ratings 最大额定值

Characteristic 特性参数	Symbol 符号	Rat 额定值	Unit 单位
Drain-Source Voltage 漏极-源极电压	BV_{DSS}	60	V
Gate- Source Voltage 栅极-源极电压	V_{GS}	± 20	V
Drain Current (continuous)漏极电流-连续	I_D (at $T_A = 25^\circ C$ at $T_A = 70^\circ C$)	10 8	A
Drain Current (pulsed)漏极电流-脉冲	I_{DM}	38	A
Total Device Dissipation 总耗散功率	$P_{TOT}(\text{at } T_A = 25^\circ C)$	3.5	W
Avalanche Energy(Single Pulse)雪崩能量	E_{AS}	36	mJ
Thermal Resistance Junction-Ambient 热阻	$R_{\theta JA}$	35	$^\circ C/W$
Junction/Storage Temperature 结温/储存温度	T_J, T_{stg}	-55~150	$^\circ C$

■ Electrical Characteristics 电特性

 (T_A=25℃ unless otherwise noted 如无特殊说明, 温度为 25℃)

Characteristic 特性参数	Symbol 符号	Min 最小值	Typ 典型值	Max 最大值	Unit 单位
Drain-Source Breakdown Voltage 漏极-源极击穿电压(I _D =250uA, V _{GS} =0V)	BV _{DSS}	60	—	—	V
Gate Threshold Voltage 栅极开启电压(I _D =250uA, V _{GS} =V _{DS})	V _{GS(th)}	1.4	—	2.4	V
Zero Gate Voltage Drain Current 零栅压漏极电流(V _{GS} =0V, V _{DS} =48V)	I _{DSS}	—	—	1	uA
Gate Body Leakage 栅极漏电流(V _{GS} =±20V, V _{DS} =0V)	I _{GSS}	—	—	±100	nA
Static Drain-Source On-State Resistance 静态漏源导通电阻(I _D =10A, V _{GS} =10V) (I _D =7A, V _{GS} =4.5V)	R _{DS(ON)}	—	15 18	22 28	mΩ
Diode Forward Voltage Drop 内附二极管正向压降(I _{SD} =10A, V _{GS} =0V)	V _{SD}	—	—	1.3	V
Input Capacitance 输入电容 (V _{GS} =0V, V _{DS} =30V, f=1MHz)	C _{ISS}	—	1370	1780	pF
Common Source Output Capacitance 共源输出电容(V _{GS} =0V, V _{DS} =30V, f=1MHz)	C _{OSS}	—	135	—	pF
Reverse Transfer Capacitance 反馈电容(V _{GS} =0V, V _{DS} =30V, f=1MHz)	C _{RSS}	—	60	—	pF
Total Gate Charge 栅极电荷密度 (V _{DS} =30V, I _D =10A, V _{GS} =10V)	Q _g	—	26	37	nC
Gate Source Charge 栅源电荷密度 (V _{DS} =30V, I _D =10A, V _{GS} =10V)	Q _{gs}	—	5	—	nC
Gate Drain Charge 栅漏电荷密度 (V _{DS} =30V, I _D =10A, V _{GS} =10V)	Q _{gd}	—	5	—	nC
Turn-ON Delay Time 开启延迟时间 (V _{DS} =30V I _D =1A, R _{GEN} =6Ω, V _{GS} =10V)	t _{d(on)}	—	14	26	ns
Turn-ON Rise Time 开启上升时间 (V _{DS} =30V I _D =1A, R _{GEN} =6Ω, V _{GS} =10V)	t _r	—	8	15	ns
Turn-OFF Delay Time 关断延迟时间 (V _{DS} =30V I _D =1A, R _{GEN} =6Ω, V _{GS} =10V)	t _{d(off)}	—	38	69	ns
Turn-OFF Fall Time 关断下降时间 (V _{DS} =30V I _D =1A, R _{GEN} =6Ω, V _{GS} =10V)	t _f	—	12	22	ns

■ Typical Characteristic Curve 典型特性曲线

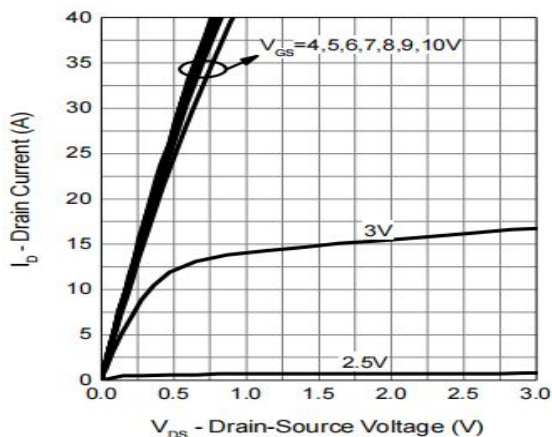


Figure 1: Output Characteristics

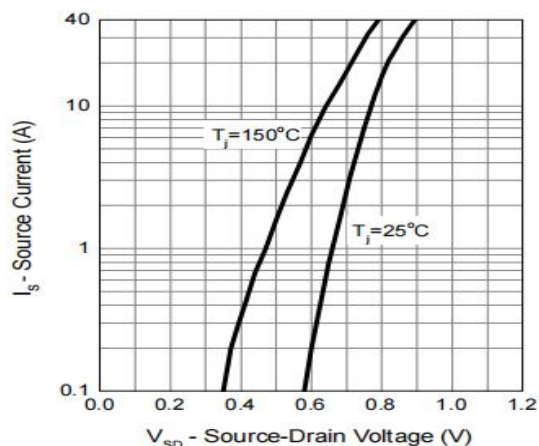


Figure 2: Diode Forward Characteristics

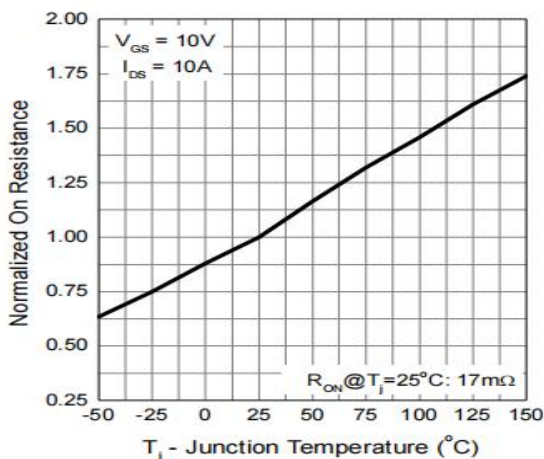


Figure 3: On-Resistance vs. T_J

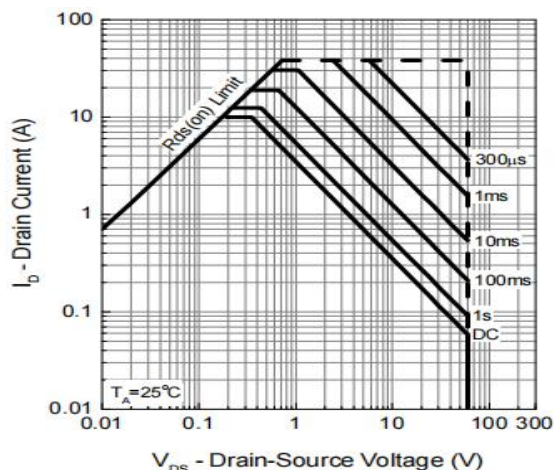


Figure 4: Safe Operating Area

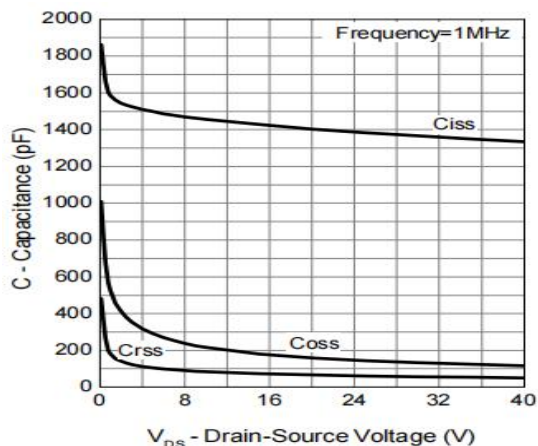


Figure 5: Capacitance Characteristics

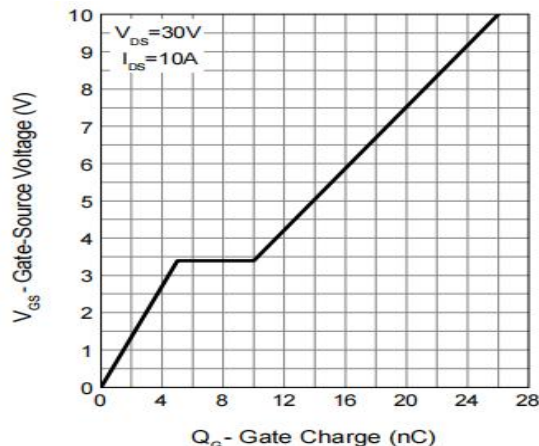
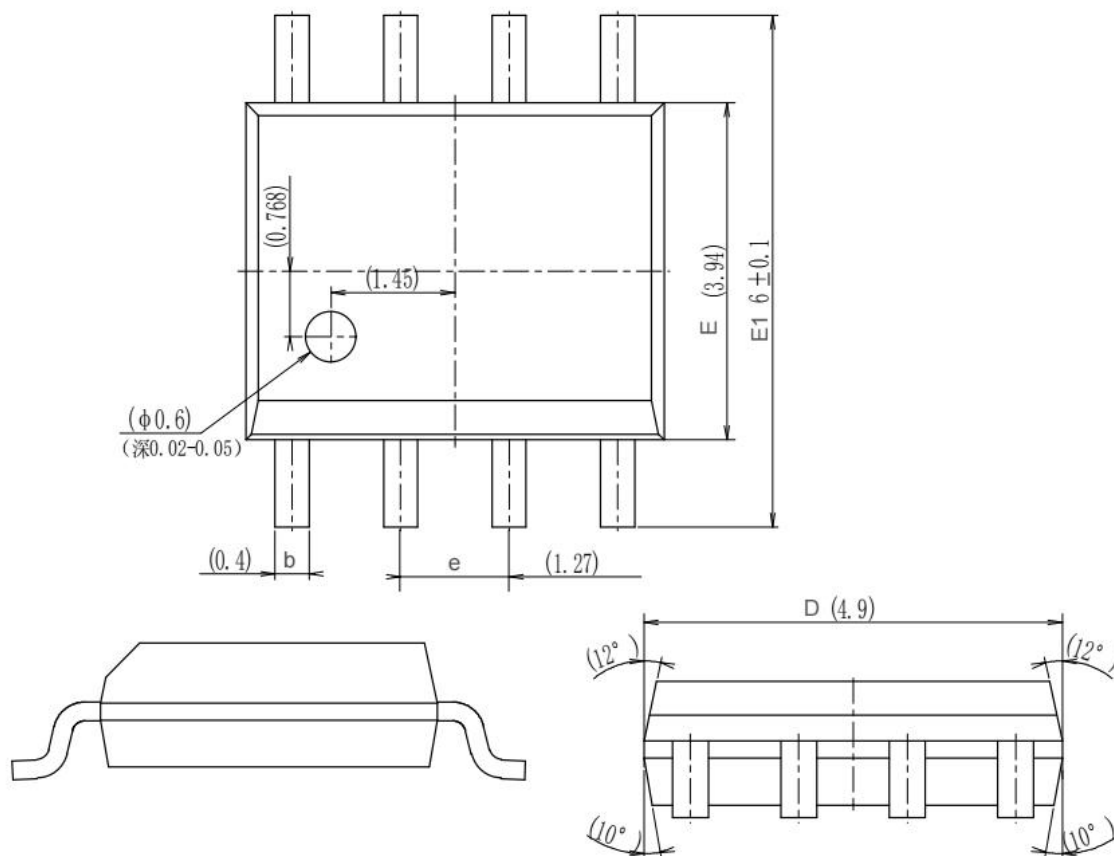


Figure 6: Gate-Charge Characteristics

■ **Dimension 外形封装尺寸**



字符	Dimension millimeters		
	Min	Standard	Max
A	1.500	1.600	1.700
A1	0.050		
A2	1.350	1.450	1.550
b	0.300	0.400	0.500
c	0.220	0.254	0.280
D	4.800	4.900	5.000
E	3.840	3.940	4.040
E1	5.900	6.000	6.100
e		1.27 (BSC)	
L	0.520	0.620	0.720
θ	0°		8°